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SH7206 Group

Example of SH7206 Initial Configuration

Introduction

This application note presents an example of initial settings to be made when the SH7206 is started up.

Target Device

SH7206

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1. Overview

1.1 Specifications

- Initial settings for the clock pulse generator (CPG), bus state controller (BSC), pin function controller (PFC), and cache are made after the reset state is exited.

1.2 MCU Functions Used

- Clock pulse generator (CPG)
- Bus state controller (BSC)
- Pin function controller (PFC)
- Cache

1.3 Conditions for Application

- MCU: SH7206 (R5S72060)
- Operating frequency:

Internal clock:	200 MHz
Bus clock:	66.67 MHz
Peripheral clock:	33.33 MHz
- Area 0 bus width: 16 bits (MD0 pin = low, MD2 pin = high)
- Clock operating mode: Mode 2 (MD_CLK0 pin = low, MD_CLK2 pin = low)
- C compiler: SuperH RISC Engine Family C/C++ Compiler Package: version 9.00
(from Renesas Technology Corp.)
- Compiler options: Default setting of HEW (-cpu = sh2a -debug -gbr = auto -global_volatile = 0
-opt_range = all -infinite_loop = 0 -del_vacant_loop = 0
-struct_alloc = 1)

1.4 Related Application Notes

Please refer to the following application notes in combination with this one.

- SH7206 application note, "Example of Setting the CPG to Change the Operating Frequency"
- SH7206 application note, "Example of BSC SDRAM Interface Setting (32-bit bus)"
- SH7206 application note, "Example of BSC Flash Memory Connection "
- SH7206 application note, "Example of Cache Memory Setting"

2. Description of Sample Application

The sample initial configuration program described in this application note is used for the applications of other SH7206 application notes.

2.1 Description of Sample Programs

The initial setting program includes the following two source programs.

- resetprog.c
- hwsetup.c

resetprog.c is created based on the file for the initialization function that is automatically generated by the HEW, and contains description of function PowerON_Reset_PC, which is to be registered with the reset vector. PowerON_Reset_PC is the first function that is executed after the chip exits from the reset state.

hwsetup.c contains description of function HardwareSetup, which is called from function PowerON_Reset_PC. In this HardwareSetup function, the clock pulse generator (CPG), bus state controller (BSC) and cache setting functions are called.

Figure 1 shows the processing flows of functions PowerON_Reset_PC and HardwareSetup.

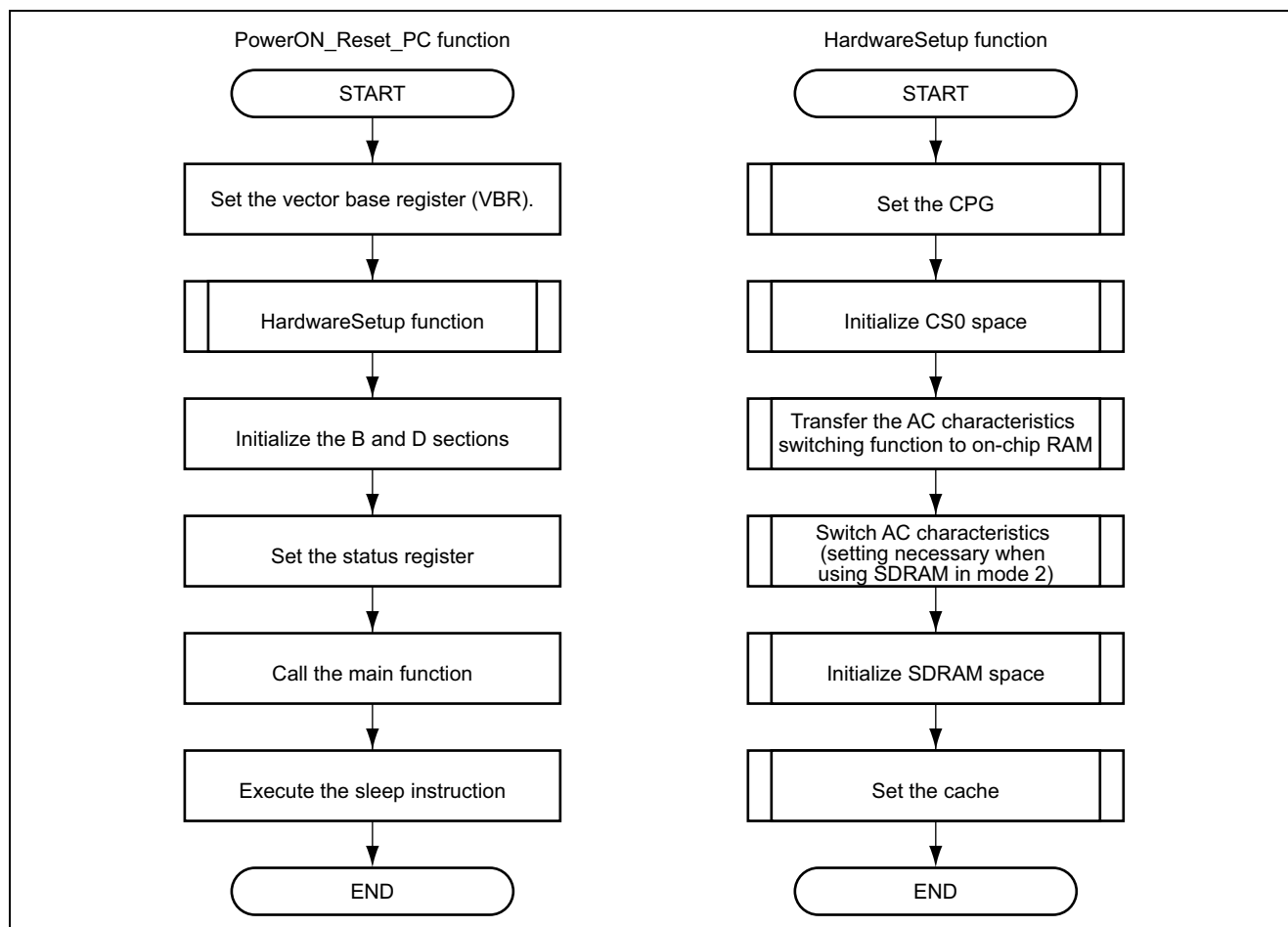


Figure 1 Processing Flows of Functions PowerON_Reset_PC and HardwareSetup

2.2 Settings Made by Sample Program

Table 1 shows the settings in the sample program.

Table 1 Settings in Sample Program

Module	Description
CPG	Internal clock: 200 MHz Bus clock: 66.67 MHz Peripheral clock: 33.33 MHz MTU clock: 100 MHz
BSC	CS0 space: Flash memory Number of access wait cycles: 6 CS3 space: SDRAM Data bus width: 32 bits Row address: 12 bits Column address: 9 bits CAS latency: 2 cycles Setting for AC characteristics switching: Sets delay time extension (necessary when using SDRAM in mode 2)
PFC	Multiplex pins are configured as address bus, data bus, and bus control pins used in CS0 and CS3.
Cache	Instruction/operand cache is enabled

2.3 Notes on Sample Program Usage

In order to allow allocation and initialization of B and D sections in the external memory, the sample program executes function `HardwareSetup` before initializing B and D sections to initialize the bus state controller. Because of this, do not use variables, such as global variables, allocated in sections that are initialized by function `_INITSCT` in those functions, including function `HardwareSetup`, that are executed before section initialization (before execution of function `_INITSCT`).

In the sample program, the interrupt mask level is set to 15 when the main function is called.

Since the function for setting the AC characteristics switching register needs to be executed in on-chip RAM, the following section setting is necessary:

From the Options pull-down menu of the HEW, select [SuperH RISC engine Standard Toolchain]. Select [linker/library] tab in the dialog box, and at the [Section to be mapped from ROM to RAM] option in the [Output] category, specify PURAM as ROM and RPURAM as RAM.

3. Sample Program Listing

1. Sample Program Listing: resetprg.c (1)

```

1  /*"FILE COMMENT"*****
2  *
3  *   System Name : SH7206 Sample Program
4  *   File Name   : resetprg.c
5  *   Version     : 1.00.00
6  *   Contents    : SH7206 initial configuration
7  *   Model       : M3A-HS60
8  *   CPU         : SH7206
9  *   Compiler    : SHC9.0.00
10 *   OS          : none
11 *
12 *   Note        : This file was originally created by the Renesas Project Generator
13 *                (Ver.3.1) and modified for the application note.
14 *
15 *                <Caution>
16 *                This sample program is for reference
17 *                and its operation is not guaranteed.
18 *                Customers should use this sample program for technical reference
19 *                in software development.
20 *
21 *   This file is generated by Renesas Project Generator (Ver.3.1).
22 *
23 *   Copyright (C) 2004 Renesas Technology Corp. All Rights Reserved
24 *   AND Renesas Solutions Corp. All Rights Reserved
25 *
26 *   history      : 2004.10.14 ver.1.00.00
27 *"FILE COMMENT END"*****
28 #include <machine.h>
29 #include <_h_c_lib.h>
30 #include "stacksct.h"
31
32 #define SR_Init    0x000000F0
33 #define INT_OFFSET 0x10
34
35 extern unsigned int INT_Vectors;
36 void PowerON_Reset_PC(void);
37 void Manual_Reset_PC(void);
38 extern void main(void);
39 extern void HardwareSetup(void);
40
41 //extern void srand(unsigned int);    // Remove the comment characters when you use rand()
42 //extern char *_slptr;                // Remove the comment characters when you use strtok()
43
44 /*==== Changing section name to ResetPRG ====*/
45 #pragma section ResetPRG
46
47 /*==== Entry function specification ====*/
48 #pragma entry PowerON_Reset_PC
49

```


2. Sample Program Listing: resetprog.c (2)

```

50  /*"FUNC COMMENT"*****
51  * ID      :
52  * Module summary: CPU initialization function
53  *-----
54  * Include      : #include "iodefine.h"
55  *-----
56  * Declaration  : void io_init_cache(void)
57  *-----
58  * Functional description:
59  *             : CPU initialization processing that is registered with the power-on
60  *             : reset exception vector table.
61  *             : This function is executed first after power-on reset.
62  *-----
63  * Argument     : None
64  *-----
65  * Return value  : None
66  *-----
67  * Note        : Commented-out processing should be enabled as necessary.
68  *
69  *"FUNC COMMENT END"*****/
70  void PowerON_Reset_PC(void)
71  {
72      /*==== Setting vector base register (VBR) ====*/
73      set_vbr((void *)((char *)&INT_Vectors - INT_OFFSET));
74
75      /*==== HardwareSetup function ====*/
76      HardwareSetup(); // Use Hardware Setup
77
78      /*==== Initializing B and D sections ====*/
79      _INITSCT();
80
81      //      errno=0;                // Remove the comment characters when you use errno
82      //      srand(1);                // Remove the comment characters when you use rand()
83      //      _slptr=NULL;            // Remove the comment characters when you use strtok()
84
85      /*==== Setting status register ====*/
86      set_cr(SR_Init);
87      nop();
88
89      /*==== Function call to main function ====*/
90      main();
91
92      /*==== Executing sleep instruction ====*/
93      sleep();
94  }
95

```

3. Sample Program Listing: resetprog.c (3)

```

96  // #pragma entry Manual_Reset_PC // Remove the comment characters when you use Manual Reset
97  /*"FUNC COMMENT"*****
98  * ID :
99  * Module summary: Manual reset processing
100 *-----
101 * Include :
102 *-----
103 * Declaration : void Manual_Reset_PC(void)
104 *-----
105 * Functional description: Function registered with the manual reset exception vector table.
106 * : No processing is defined in the sample program.
107 * : Add processing as necessary.
108 *-----
109 * Argument : None
110 *-----
111 * Return value : None
112 *-----
113 * None : None
114 *"FUNC COMMENT END"*****/
115 void Manual_Reset_PC(void)
116 {
117     /* NOP */
118 }
119 /* END of File */

```

4. Sample Program Listing: hwsetup.c (1)

```

1  /*"FILE COMMENT"*****
2  *
3  *   System Name : SH7206 Sample Program
4  *   File Name   : hwsetup.c
5  *   Version     : 1.00.00
6  *   Contents    : Hardware initialization function
7  *   Model       : M3A-HS60
8  *   CPU         : SH7206
9  *   Compiler    : SHC9.0.00
10 *   OS          : none
11 *
12 *   note        :
13 *               <Caution>
14 *               This sample program is for reference
15 *               and its operation is not guaranteed.
16 *               Customers should use this sample program for technical reference
17 *               in software development.
18 *
19 *   Copyright (C) 2005 Renesas Technology Corp. All Rights Reserved
20 *   AND Renesas Solutions Corp. All Rights Reserved
21 *
22 *   history      : 2004.10.14 ver.1.00.00
23 *   history      : 2005.02.21 ver.1.00.01 AC characteristics switching setting added
24 *"FILE COMMENT END"*****/
25 #include "iodefine.h"
26
27 /* Remove this #define directive when you use clock mode7 */
28 #define USE_CLKMODE2
29
30 /* ==== Prototype declarations ==== */
31 void HardwareSetup(void);
32 static void init_puram_section(void);
33 void set_acswr(void);
34
35
36 /* ==== Externally referenced prototype declarations ==== */
37 extern void io_set_cpg(void);
38 extern void io_init_bsc_cs0(void);
39 extern void io_init_sdram(void);
40 extern void io_init_cache(void);
41
42

```

5. Sample Program Listing: hwsetup.c (2)

```

43  /*"FUNC COMMENT"*****
44  * ID      :
45  * Module summary: Hardware initialization function
46  *-----
47  * Include      : #include "iodefine.h"
48  *-----
49  * Declaration  : void  HardwareSetup(void)
50  *-----
51  * Functional description: Initializes the CPG, PFC, and BSC
52  *                   : (flash memory access control and SDRAM initialization)
53  *-----
54  * Argument     : None
55  *-----
56  * Return value  : None
57  *-----
58  * Functions used:
59  *-----
60  * Note        :
61  *"FUNC COMMENT END"*****/
62  void  HardwareSetup(void)
63  {
64      /*==== Configuring the CPG ====*/
65      io_set_cpg();
66
67      /*==== CS0 initialization ====*/
68      io_init_bsc_cs0();
69
70  #ifdef USE_CLKMODE2
71      /*==== Setting AC characteristics switching ====*/
72      init_puram_section();
73      set_acswr();
74  #endif
75      /*==== SDRAM space initialization ====*/
76      io_init_sdram();
77
78      /*==== Setting the cache ====*/
79      io_init_cache();
80  }
81
82

```

6. Sample Program Listing: hwsetup.c (3)

```

83  /*"FUNC COMMENT"*****
84  * ID      :
85  * Module summary: Program section transfer from ROM to on-chip RAM
86  *-----
87  * Include      : #include "iodefine.h"
88  *-----
89  * Declaration   : static void init_puram_section(void)
90  *-----
91  * Function      : Transfers URAM section from ROM to on-chip RAM
92  *-----
93  * Argument      : None
94  *-----
95  * Return value   : None
96  *-----
97  * Functions used:
98  *-----
99  * Note          : A separate function is used to transfer PURAM section because set_acswr
100 *                : must be transferred prior to section initialization by _INITISCT().
101 *"FUNC COMMENT END"*****/
102 static void init_puram_section(void)
103 {
104     unsigned long *src,*end,*dst;
105
106     src = (unsigned long *)__sectop("PURAM");
107     end = (unsigned long *)__secend("PURAM");
108     dst = (unsigned long *)__sectop("RPURAM");
109
110     while(src < end){
111         *dst++ = *src++;
112     }
113 }
114
115 #pragma section URAM
116 /*"FUNC COMMENT"*****
117 * ID      :
118 * Module summary: AC characteristics switching function
119 *-----
120 * Include      : #include "iodefine.h"
121 *-----
122 * Declaration   : void set_acswr(void)
123 *-----
124 * Function      : Changes delay time extension in AC characteristics.
125 *-----
126 * Argument      : None
127 *-----
128 * Return value   : None
129 *-----
130 * Functions used:
131 *-----
132 * Note          : This setting is necessary when SDRAM is used in clock mode 2.
133 *                : This function must be executed on URAM.
134 *                : This setting must not be made in clock mode 7.
135 *"FUNC COMMENT END"*****/
136 void set_acswr(void)
137 {
138     volatile unsigned long reg;
139
140     do{
141         /* ==== Setting AC characteristics switching ==== */
142         AC.ACKEYR.BYTE = 0;          /* Write byte data twice to the AC */
143         AC.ACKEYR.BYTE = 0;          /* characteristics switching key register (ACKEYR)*/
144         AC.ACSWR.LONG = 0x9;         /* Set delay time extension */
145     }while(AC.ACSWR.LONG != 0x9);
146 }
147 /* End of File */
148

```

7. Sample Program Listing: cpq.c (1)

```

1  /*"FILE COMMENT"*****
2  *
3  *   System Name: SH7206 Sample Program
4  *   File Name   : cpq.c
5  *   Version     : 1.00.00
6  *   Contents    : CPG setting processing
7  *   Model       : M3A-HS60
8  *   CPU         : SH7206
9  *   Compiler    : SHC9.0.00
10 *   OS          : none
11 *
12 *   note        :
13 *               <Caution>
14 *               This sample program is for reference
15 *               and its operation is not guaranteed.
16 *               Customers should use this sample program for technical reference
17 *               in software development.
18 *
19 *   Copyright (C) 2004 Renesas Technology Corp. All Rights Reserved
20 *   AND Renesas Solutions Corp. All Rights Reserved
21 *
22 *   history     : 2004.10.14 ver.1.00.00
23 *"FILE COMMENT END"*****
24 #include "iodefine.h"
25
26 /* ==== Prototype declaration ==== */
27 void io_set_cpq(void);
28
29 /*"FUNC COMMENT"*****
30 * ID           :
31 * Module summary: CPG setting
32 *-----
33 * Include      : #include "iodefine.h"
34 *-----
35 * Declaration  : void io_set_cpq(void)
36 *-----
37 * Functional description:
38 *               : Configures the clock pulse generator (CPG) as follows:
39 *               : Internal clock (I Clock) = 200 MHz, bus clock (B Clock) = 66.6 MHz,
40 *               : peripheral clock (P Clock) = 33.3 MHz, and MTU clock (M Clock) = 100 MHz
41 *-----
42 * Argument     : None
43 *-----
44 * Return value : None
45 *-----
46 * Note        : The settings made by this function are example when the input clock is
47 *               : 16.6 MHz in clock mode 2.
48 *"FUNC COMMENT END"*****
49 void io_set_cpq(void)
50 {
51     /* ==== CPG Setting ==== */
52     WDT.WTCSR.WORD = 0xa51e;          /* Stop WDT; set WDT counter clock division ratio*/
53                                     /* 1/4096 x P-phi (33.3MHz) */
54     WDT.WTCNT.WORD = 0x5aad;          /* Initial counter value: D'173 (= 10 ms ) */
55     CPG.FRQCR.WORD = 0x120c;          /* PLL1(x3),PLL2(x4),I:B:P=12:4:2
56                                     * Clockin = 16.67 MHz, CKIO = 66.6 MHz
57                                     * I Clock = 200 MHz, B Clock = 66.6 MHz,
58                                     * P Clock = 33.3 MHz
59                                     */
60     CPG.MCLKCR.BYTE = 0x41;          /* MTU = 100 MHz */
61 }
62
63 /* End of File */
64
65

```

8. Sample Program Listing: bsc_cs0.c (1)

```

1  /*"FILE COMMENT"*****
2  *
3  *   System Name: SH7206 Sample Program
4  *   File Name   : bsc_cs0.c
5  *   Version     : 1.00.00
6  *   Contents    : SH7206 initial configuration
7  *   Model       : M3A-HS60
8  *   CPU         : SH7206
9  *   Compiler    : SHC9.0.00
10 *   OS          : none
11 *
12 *   note        :
13 *               <Caution>
14 *               This sample program is for reference
15 *               and its operation is not guaranteed.
16 *               Customers should use this sample program for technical reference
17 *               in software development.
18 *
19 *   Copyright (C) 2004 Renesas Technology Corp. All Rights Reserved
20 *   AND Renesas Solutions Corp. All Rights Reserved
21 *
22 *   history      : 2004.10.01 ver.1.00.00
23 *               : 2005.03.17 ver.1.00.01 Wait Invalidity
24 *"FILE COMMENT END"*****/
25 #include "iodefine.h"
26
27 /* ==== Prototype declaration ==== */
28 void io_init_bsc_cs0(void);

```

9. Sample Program Listing: bsc_cs0.c (2)

```

29  /*"FUNC COMMENT"*****
30  * ID      :
31  * Module summary : CS0 setting
32  *-----
33  * Include      : #include "iodefine.h"
34  *-----
35  * Declaration   : void io_init_bsc_cs0(void)
36  *-----
37  * Functional description: Configures the pin function controller (PFC) and the bus state
38  *                      : controller (BSC) to set timing of access to flash memory in the CS0 space.
39  *-----
40  * Argument      : None
41  *-----
42  * Return value   : None
43  *-----
44  * Note          : The PFC is set by bit manipulation so as not to change the PFC setting
45  *                : values set by other processing.
46  *"FUNC COMMENT END"*****
47  void io_init_bsc_cs0(void)
48  {
49      /* ==== Setting PFC ==== */
50      PORT.PACRL4.BIT.PA12MD = 0x1;      /* Specify as WE0 output          */
51      PORT.PBCR3.BIT.PB9MD  = 0x2;      /* A21 output                    */
52
53      /* ==== Setting CS0 space bus control register (CS0BCR) ==== */
54      BSC.CS0BCR.LONG = 0x20000400ul;
55
56      /* Idle cycle insertion between write and read          */
57      /* cycles or between write and write cycles:            */
58      /* 2 idle cycles.                                         */
59      /* Data bus width: 16 bits                                */
60
61      /* ==== Setting CS0 space wait control register (CS0WCR) ==== */
62      BSC.UN0_BSC.NORMAL.REG_CS0WCR.LONG = 0x00000b41ul;
63
64      /* Addr,CS assert -> RD,WE assert delay cycles          */
65      /* : 1.5 cycles                                           */
66      /* Access wait cycles: 6 cycles                           */
67      /* Ignore external wait input                             */
68      /* CS,RD,WE negate -> Addr,CS negate delay cycles        */
69      /* : 1.5 cycles                                           */
70  }
71  /* End of File */

```


10. Sample Program Listing: bscsdram.c (1)

```

1  /*"FILE COMMENT"*****
2  *
3  *   System Name: SH7206 Sample Program
4  *   File Name  : bscsdram.c
5  *   Version    : 1.00.00
6  *   Contents   : SH7206 initial configuration
7  *   Model      : M3A-HS60
8  *   CPU        : SH7206
9  *   Compiler   : SHC9.0.00
10 *   OS         : none
11 *
12 *   note       :
13 *               <Caution>
14 *               This sample program is for reference
15 *               and its operation is not guaranteed.
16 *               Customers should use this sample program for technical reference
17 *               in software development.
18 *
19 *   Copyright (C) 2004 Renesas Technology Corp. All Rights Reserved
20 *   AND Renesas Solutions Corp. All Rights Reserved
21 *
22 *       history   : 2004.10.14 ver.1.00.00
23 *"FILE COMMENT END"*****/
24 #include "iodefine.h"
25
26 /* ==== Macro definition ==== */
27
28 /* Access address for writing to the SDRAM mode register */
29 #define    SDRAM_MODE        (*(volatile unsigned short *) (0xfffc5880))
30
31 /* ==== Prototype declaration ==== */
32 void io_init_sdram(void);
33

```

11. Sample Program Listing: bscsdram.c (2)

```

34  /*"FUNC COMMENT"*****
35  * ID      :
36  * Module summary: Setting for 32-bit bus width connection with SDRAM
37  *-----
38  * Include      : #include "iodefine.h"
39  *-----
40  * Declaration  : void io_init_sdram(void)
41  *-----
42  * Functional description:
43  *             : Configure the pin function controller (PFC) and the bus state
44  *             : controller (BSC) to enable SDRAM in the CS3 space.
45  *-----
46  * Argument     : None
47  *-----
48  * Return value  : None
49  *-----
50  * Note         : The PFC is set by bit manipulation so as not to change the PFC setting
51  *             : values set by other processing.
52  *"FUNC COMMENT END"*****
53  void io_init_sdram(void)
54  {
55      volatile int j = 40000;          /* 200 usec wait count @200 MHz          */
56
57      /* ==== PFC setting ==== */
58      PORT.PACRH2.BIT.PA23MD = 0x1;    /* DQM0U output          */
59      PORT.PACRH2.BIT.PA22MD = 0x1;    /* DQM1U output          */
60      PORT.PACRL4.BIT.PA13MD = 0x1;    /* DQMLU output          */
61      PORT.PACRL4.BIT.PA12MD = 0x1;    /* DQMLL output          */
62      PORT.PACRL3.BIT.PA9MD = 0x5;     /* CKE output            */
63      PORT.PACRL3.BIT.PA8MD = 0x5;     /* RD/WR# output         */
64      PORT.PACRL2.BIT.PA7MD = 0x2;     /* CS3 output            */
65      PORT.PBCR2.BIT.PB5MD = 0x4;     /* CASL output           */
66      PORT.PBCR2.BIT.PB4MD = 0x4;     /* RASL output           */
67
68      PORT.PDCRH4.WORD = 0x1111;       /* D31-D28 input/output  */
69      PORT.PDCRH3.WORD = 0x1111;       /* D27-D24 input/output  */
70      PORT.PDCRH2.WORD = 0x1111;       /* D23-D20 input/output  */
71      PORT.PDCRH1.WORD = 0x1111;       /* D19-D16 input/output  */
72
73      /* ==== Setting CS3 space bus control register (CS3BCR) ==== */
74      BSC.CS3BCR.LONG = 0x10004600ul; /*
75      * Idle cycle insertion between write and read cycles
76      * or between write and write cycles: 1 idle cycle
77      * Memory type      : SDRAM
78      * Data bus width   : 32 bits
79      */
80      /* ==== Setting CS3 space wait control register (CS3WCR) ==== */
81      BSC.UN2_BSC.SDRAM.REG_CS3WCR.LONG = 0x00004892ul; /*
82      *
83      * Precharge cycles: 2 cycles
84      * Wait cycles between ACT -> READ commands
85      *                   : 2 cycles
86      * Area 3 CAS latency      : 2 cycles
87      * Precharge activation cycles: 2 cycles
88      * Idle cycles between REF -> ACT/REF/MRS commands
89      *                   : 5 cycles
90      */

```

12. Sample Program Listing: bscsdram.c (3)

```

91      /* ==== Setting SDRAM control register (SDCR) ==== */
92      BSC.SDCR.LONG = 0x00000809ul;      /*
93                                          * Refresh control 1      : Perform refresh
94                                          * Refresh control 2      : Auto refresh
95                                          * Bank active mode
96                                          *                               : Auto precharge mode
97                                          * Area 3 row address      : 12 bits
98                                          * Area 3 column address   : 9 bits
99                                          */
100     /* ==== Setting refresh timer constant register (RTCOR) ==== */
101     BSC.RTCOR.LONG = 0xa55a0041ul;      /*
102                                          * Refresh interval:
103                                          * 15.625 usec/240 nsec = 64(0x41) cycles
104                                          */
105     /* ==== Setting refresh timer control/status register (RTCSR) setting ==== */
106     BSC.RTCSR.LONG = 0xa55a0010ul;      /*
107                                          * Start initialization sequence
108                                          * Clock select: B phi 16: 1 cycle = 240 nsec
109                                          * Refresh cycle count: once
110                                          */
111     /* ==== Has 200 usec duration elapsed? ==== */
112     while(j-- > 0){
113         /* wait */
114     }
115
116     /* ==== Writing to SDRAM mode register ==== */
117     SDRAM_MODE = 0;                      /*
118                                          * Arbitrary data may be written
119                                          * SDRAM mode register setting for CS3 space
120                                          * Burst read (burst length: 1)/single write
121                                          */
122 }
123 /* End of File */

```

13. Sample Program Listing: cache.c (1)

```

1  /*"FILE COMMENT"*****
2  *
3  *   System Name: SH7206 Sample Program
4  *   File Name   : cache.c
5  *   Version    : 1.00.00
6  *   Contents   : sample of cache register
7  *   Model      : M3A-HS60
8  *   CPU        : SH7206
9  *   Compiler   : SHC9.0.00
10 *   OS         : none
11 *
12 *   note       : Sample program for setting the cache
13 *
14 *               <Caution>
15 *               This sample program is for reference
16 *               and its operation is not guaranteed.
17 *               Customers should use this sample program for technical reference
18 *               in software development.
19 *
20 *   Copyright (C) 2004 Renesas Technology Corp. All Rights Reserved
21 *   AND Renesas Solutions Corp. All Rights Reserved
22 *
23 *   history    : 2004.08.24 ver.0.01.00
24 *"FILE COMMENT END"*****
25 #include <machine.h>
26 #include "iodefine.h"
27
28 /* ==== Prototype declaration ==== */
29 void io_init_cache(void);
30

```

14. Sample Program Listing: cache.c (2)

```

31 #pragma section CACHE          /* This section is to be allocated in non-cacheable CS0 space */
32 /*"FUNC COMMENT"*****
33 * ID :
34 * Module summary: Cache initialization
35 *-----
36 * Include : #include "iodefine.h"
37 *-----
38 * Declaration : void io_init_cache(void)
39 *-----
40 * Function : Flushes and enables the instruction/operand cache.
41 * :
42 *-----
43 * Argument : None
44 *-----
45 * Return value : None
46 *-----
47 * Note : The section name for this function has been changed because the program
48 * : should be allocated in non-cacheable space.
49 * : If this function is only used with the interrupt mask level 15,
50 * : interrupt mask setting/clearing processing is not necessary.
51 *"FUNC COMMENT END"*****/
52 void io_init_cache(void)
53 {
54     volatile unsigned long reg;
55     int mask;
56
57     /* ==== Setting the interrupt mask ==== */
58     mask = get_imask();
59     set_imask(15); /* Set to level 15 */
60
61     /* ==== Setting the cache register ==== */
62     CCNT.CCR1.LONG = 0x0909ul; /*
63                                ICF=1: Flushes instruction cache
64                                ICE=1: Enables instruction cache
65                                OCF=1: Flushes operand cache
66                                WT =0: Cache write back mode
67                                OCE=1: Enables operand cache
68                                */
69
70     /* ==== Reading the cache register ==== */
71     reg = CCNT.CCR1.LONG ;
72
73     /* ==== Clearing the interrupt mask ==== */
74     set_imask(mask); /* Set to the original level */
75 }
76
77
78 /* End of File */

```

4. Reference Documents

- SH-2A SH2A-FPU Software Manual (Rev.3.00)
(Download the latest edition from the website of Renesas Technology Corp.)
- SH7206 Group Hardware Manual (Rev. 1.00)
(Download the latest edition from the website of Renesas Technology Corp.)

5. Website

- Website of Renesas Technology Corp.
<http://www.renesas.com/>

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Sep.05.05	—	First edition issued

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